# Quad MECL-to-TTL Translator

# Description

The MC10H125 is a quad translator for interfacing data and control signals between the MECL section and saturated logic section of digital systems. The 10H part is a functional/pinout duplication of the standard MECL  $10K^{TM}$  family part, with 100% improvement in propagation delay, and no increase in power-supply current.

Outputs of unused translators will go to low state when their inputs are left open.

#### **Features**

- Propagation Delay, 2.5 ns Typical
- Voltage Compensated
- Improved Noise Margin 150 mV (Over Operating Voltage and Temperature Range)
- MECL 10K Compatible
- · These Devices are Pb-Free, Halogen Free and are RoHS Compliant



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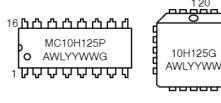
#### www.onsemi.com





PDIP-16 P SUFFIX CASE 648-08 PLLC-20 FN SUFFIX CASE 775-02

#### MARKING DIAGRAMS\*



PDIP-16

PLLC-20

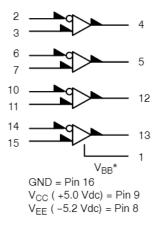
A = Assembly Location
WL, L = Wafer Lot
YY, Y = Year
WW, W = Work Week
G = Pb-Free Package

\*For additional marking information, refer to Application Note <u>AND8002/D</u>.

### ORDERING INFORMATION

Device	Package	Shipping†
MC10H125FNG	PLLC-20 (Pb-Free)	46 Units / Tube
MC10H125FNR2G	PLLC-20 (Pb-Free)	500 Tape & Reel
MC10H125PG	PDIP-16 (Pb-Free)	25 Units / Tube

<sup>†</sup>For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.



 $^*V_{BB}$  to be used to supply bias to the MC10H125 only and bypassed (when used) with 0.01  $\mu F$  to 0.1  $\mu F$  capacitor to ground (0 V).  $V_{BB}$  can source < 1.0 mA.

Figure 1. Logic Diagram

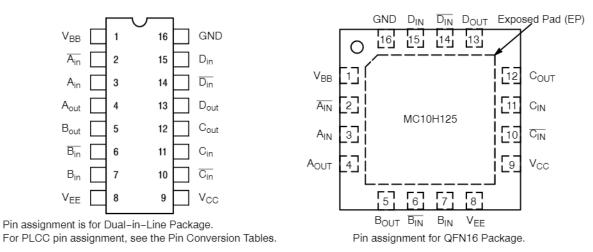


Figure 2. Pin Assignment

Table 1. DIP CONVERSION TABLES

16-Pin DIL to 20-Pin PLCC																				
16 PIN DIL	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16				
20 PIN PLCC	2	3	4	5	7	8	9	10	12	13	14	15	17	18	19	20				
20-Pin DIL to 20-Pin PLCC																				
20 PIN DIL	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16	17	18	19	20
20 PIN PLCC	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16	17	18	19	20

Table 2. MAXIMUM RATINGS

Symbol	Characteristic	Rating	Unit
V <sub>EE</sub>	Power Supply (V <sub>CC</sub> = 5.0 V)	-8.0 to 0	Vdc
V <sub>CC</sub>	Power Supply (V <sub>EE</sub> = -5.2 V)	0 to +7.0	Vdc
VI	Input Voltage (V <sub>CC</sub> = 5.0 V)	0 to V <sub>EE</sub>	Vdc
T <sub>A</sub>	Operating Temperature Range	0 to +75	°C
T <sub>stg</sub>	Storage Temperature Range - Plastic - Ceramic	-55 to +150 -55 to +165	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

Table 3. ELECTRICAL CHARACTERISTICS ( $V_{EE} = -5.2 \text{ V} + 5\%$ ;  $V_{CC} = 5.0 \text{ V} + 5.0 \%$ ) (Note 2)

		<b>0</b> °		2	5°	-	75°			
Symbol	Characteristic	Min	Max	Min	Max	Min	Max	Unit		
IE	Negative Power Supply Drain Current	-	44	-	40	-	44	mA		
I <sub>CCH</sub>	Positive Power Supply	-	63	-	63	-	63	mA		
I <sub>CCL</sub>	Drain Current	-	40	-	40	-	40	mA		
I <sub>inH</sub>	Input Current	-	225	-	145	-	145	μА		
I <sub>CBO</sub>	Input Leakage Current	-	1.5	-	1.0	-	1.0	μА		
V <sub>OH</sub>	High Output Voltage I <sub>OH</sub> = -1.0 mA	2.5	-	2.5	-	2.5	-	Vdc		
V <sub>OL</sub>	Low Output Voltage I <sub>OL</sub> = +20 mA	-	0.5	-	0.5	-	0.5	Vdc		
V <sub>IH</sub>	High Input Voltage (Note 1)	-1.17	-0.84	-1.13	-0.81	-1.07	-0.735	Vdc		
V <sub>IL</sub>	Low Input Voltage (Note 1)	-1.95	-1.48	-1.95	-1.48	-1.95	-1.45	Vdc		
Ios	Short Circuit Current	60	150	60	150	50	150	mA		
V <sub>BB</sub>	Reference Voltage	-1.38	-1.27	-1.35	-1.25	-1.31	-1.19	Vdc		
V <sub>CMR</sub>	Common Mode Range (Note 3)	-	-	-2.85	to +0.3			V		
		Typical								
V <sub>PP</sub>	Input Sensitivity (Note 4)		150							

When V<sub>BB</sub> is used as the reference voltage.
 Each MECL 10H™ series circuit has been designed to meet the specifications shown in the test table, after thermal equilibrium has been established. The circuit is in a test socket or mounted on a printed circuit board and transverse air flow greater than 500 linear fpm is maintained.

Differential input not to exceed 1.0 Vdc.
 150 mV<sub>p-p</sub> differential input required to obtain full logic swing on output.

**Table 4. AC CHARACTERISTICS** 

		<b>0</b> °		2	5°	7		
Symbol	Characteristic	Min	Max	Min	Max	Min	Max	Unit
t <sub>pd</sub>	Propagation Delay	0.8	3.3	0.85	3.35	0.9	3.4	ns
t <sub>r</sub>	Rise Time (Note 1)	0.3	1.2	0.3	1.2	0.3	1.2	ns
t <sub>f</sub>	Fall Time (Note 1)	0.3	1.2	0.3	1.2	0.3	1.2	ns

NOTE: Device will meet the specifications after thermal equilibrium has been established when mounted in a test socket or printed circuit board with maintained transverse airflow greater than 500 lfpm. Electrical parameters are guaranteed only over the declared operating temperature range. Functional operation of the device exceeding these conditions is not implied. Device specification limit values are applied individually under normal operating conditions and not valid simultaneously.

1. Output Voltage = 1.0 V to 2.0 V. R<sub>L</sub> = 500  $\Omega$  to GND and C<sub>L</sub> = 25 pF to GND. Refer to Figure 1.

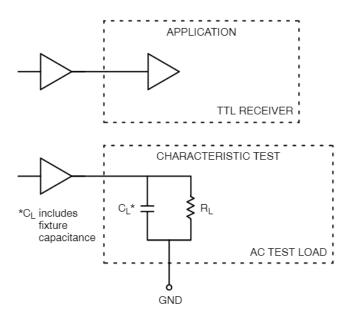


Figure 1. TTL Output Loading Used for Device Evaluation

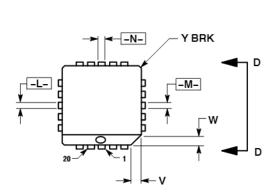
# APPLICATION INFORMATION

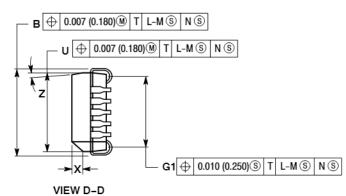
The MC10H125 incorporates differential inputs and Schottky TTL "totem pole" outputs. Differential inputs allow for use as an inverting/non-inverting translator or as a differential line receiver. The  $V_{BB}$  reference voltage is available on Pin 1 for use in single-ended input biasing. The outputs of the MC10H125 go to a low-logic level whenever the inputs are left floating, and a high-logic output level is achieved with a minimum input level of 150 m $V_{p-p}$ .

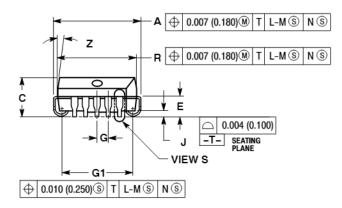
An advantage of this device is that MECL-level information can be received, via balanced twisted pair lines, in the TTL equipment. This isolates the MECL-logic from the noisy TTL environment. Power supply requirements are ground, +5.0 V and -5.2 V.

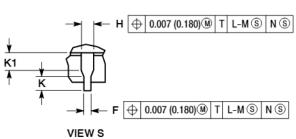
#### PACKAGE DIMENSIONS

# 20 LEAD PLLC **FN SUFFIX** CASE 775-02 ISSUE F









- 1. DIMENSIONS AND TOLERANCING PER ANSI Y14.5M,
- DIMENSIONS IN INCHES.
   DIMENSIONS IN INCHES.
   DATUMS -L-, -M-, AND -N- DETERMINED WHERE TOP OF LEAD SHOULDER EXITS PLASTIC BODY AT MOLD PARTING LINE.
- DIMENSION G1, TRUE POSITION TO BE MEASURED AT DATUM -T-, SEATING PLANE.
- DATUM -T-, SEATING PLANE.

  DIMENSIONS R AND U DO NOT INCLUDE MOLD FLASH.

  ALLOWABLE MOLD FLASH IS 0.010 (0.250) PER SIDE.

  DIMENSIONS IN THE PACKAGE TOP MAY BE SMALLER

  THAN THE PACKAGE BOTTOM BY UP TO 0.012 (0.300).

  DIMENSIONS R AND U ARE DETERMINED AT THE

  OUTERMOST EXTREMES OF THE PLASTIC BODY

  EXCLUSIVE OF MOLD FLASH, TIE BAR BURRS, GATE

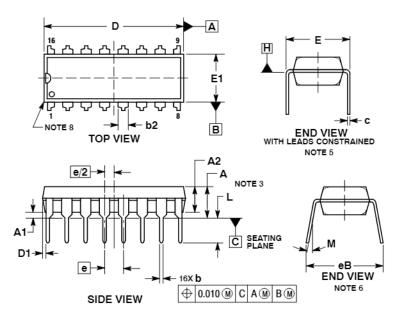
  BURRS AND INTERLEAD FLASH, BUT INCLUDING ANY
  MISMATCH BETWEEN THE TOP AND BOTTOM OF THE
  PLASTIC BODY
- PLASTIC BODY.

  7. DIMENSION H DOES NOT INCLUDE DAMBAR
  PROTRUSION OR INTRUSION. THE DAMBAR
  PROTRUSION(S) SHALL NOT CAUSE THE H DIMENSION
  TO BE GREATER THAN 0.037 (0.940). THE DAMBAR
  INTRUSION(S) SHALL NOT CAUSE THE H DIMENSION TO BE SMALLER THAN 0.025 (0.635).

	INC	HES	MILLIN	ETERS
DIM	MIN	MAX	MIN	MAX
Α	0.385	0.395	9.78	10.03
В	0.385	0.395	9.78	10.03
C	0.165	0.180	4.20	4.57
E	0.090	0.110	2.29	2.79
F	0.013	0.021	0.33	0.53
G	0.050	BSC	1.27	BSC
Н	0.026	0.032	0.66	0.81
J	0.020		0.51	
K	0.025		0.64	
R	0.350	0.356	8.89	9.04
U	0.350	0.356	8.89	9.04
٧	0.042	0.048	1.07	1.21
W	0.042	0.048	1.07	1.21
Х	0.042	0.056	1.07	1.42
Υ		0.020		0.50
Z	2°	10°	2°	10 °
G1	0.310	0.330	7.88	8.38
K1	0.040		1.02	

#### PACKAGE DIMENSIONS

# PDIP-16 P SUFFIX CASE 648-08 ISSUE V



#### NOTES

- 1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994
- CONTROLLING DIMENSION: INCHES.

  DIMENSIONS A, A1 AND L ARE MEASURED WITH THE PACKAGE SEATED IN JEDEC SEATING PLANE GAUGE GS-3.

  DIMENSIONS D, D1 AND E1 D0 NOT INCLUDE MOLD FLASH
- OR PROTRUSIONS. MOLD FLASH OR PROTRUSIONS ARE
- NOT TO EXCEED 0.10 INCH.
  DIMENSION E IS MEASURED AT A POINT 0.015 BELOW DATUM PLANE H WITH THE LEADS CONSTRAINED PERPENDICULAR TO DATUM C.
- DIMENSION 68 IS MEASURED AT THE LEAD TIPS WITH THE LEADS UNCONSTRAINED.
- DATUM PLANE H IS COINCIDENT WITH THE BOTTOM OF THE LEADS, WHERE THE LEADS EXIT THE BODY. PACKAGE CONTOUR IS OPTIONAL (ROUNDED OR SQUARE
- CORNERS)

	INC	HES	MILLIMETERS				
DIM	MIN	MAX	MIN	MAX			
Α		0.210		5.33			
A1	0.015		0.38				
A2	0.115	0.195	2.92	4.95			
b	0.014	0.022	0.35	0.56			
b2	0.060	TYP	1.52 TYP				
С	0.008	0.014	0.20	0.36			
D	0.735	0.775	18.67	19.69			
D1	0.005		0.13				
Е	0.300	0.325	7.62	8.26			
E1	0.240	0.280	6.10	7.11			
е	0.100	0.100 BSC		BSC			
eВ		0.430		10.92			
L	0.115	0.150	2.92	3.81			
M		10°		10°			

STYLE 1	:	STYLE 2:	
PIN 1.	CATHODE	PIN 1.	COMMON DRAIN
2.	CATHODE	2.	COMMON DRAIN
3.	CATHODE	3.	COMMON DRAIN
4.	CATHODE	4.	COMMON DRAIN
5.	CATHODE	5.	COMMON DRAIN
6.	CATHODE	6.	COMMON DRAIN
7.	CATHODE	7.	COMMON DRAIN
8.	CATHODE	8.	COMMON DRAIN
9.	ANODE	9.	GATE
	ANODE		SOURCE
11.	ANODE	11.	GATE
12.	ANODE	12.	SOURCE
13.	ANODE	13.	GATE
14.	ANODE	14.	SOURCE
15.	ANODE	15.	GATE
16	ANODE	16	SOURCE

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